

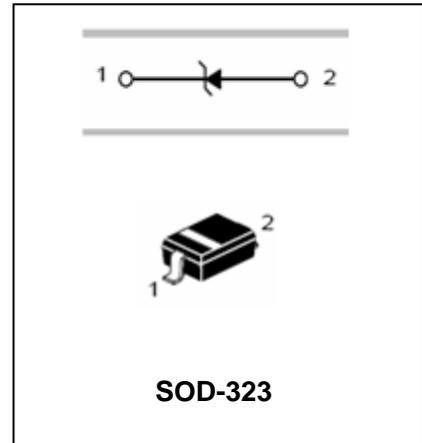


Single Line TVS Diode

GESDXVD3

FEATURES

- Suitable replacement for MLV'S ESD protection
- Low leakage current
- Low clamping voltage



APPLICATIONS

- Single line TVS diode
- Computers and peripherals
- Communication systems
- Audio and video equipment

ORDERING INFORMATION

Type No.	Marking	Package Code
GESD3V3D3	N1	SOD-323
GESD5V0D3	5U	SOD-323
GESD12VD3	N3	SOD-323
GESD15VD3	N4	SOD-323
GESD24VD3	N5	SOD-323

MAXIMUM RATING @ Ta=25°C unless otherwise specified

Parameter	Symbol	Limits	Unit
Reverse standoff voltage	V_{RWM}	GESD3V3D3	3.3
		GESD5V0D3	5
		GESD12VD3	12
		GESD15VD3	15
		GESD24VD3	24
Peak pulse power dissipation($t_p=8/20\mu s$)	P_{PP}	GESD3V3D3	330
		GESD5V0D3	260
		GESD12VD3	180
		GESD15VD3	160
		GESD24VD3	160
Peak pulse current($t_p=8/20\mu s$)	I_{PP}	GESD3V3D3	18
		GESD5V0D3	15
		GESD12VD3	5
		GESD15VD3	5
		GESD24VD3	3



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Parameter	Symbol	Limits	Unit
ESD (electrostatic discharge capability)	GESD3V3D3	30	kV
	GESD5V0D3	30	
	GESD12VD3	30	
	GESD15VD3	30	
	GESD24VD3	23	
Junction temperature	T _j	150	°C
Storage and operating temperature	T _{STG} T _{amb}	-65 to+150	°C

ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Reverse breakdown voltage	V _{BR}	I _R =5mA				V	
		GESD3V3D3	5.2	5.6	6.0		
		GESD5V0D3	6.4	6.8	7.2		
		GESD12VD3	14.7	15.0	15.3		
		GESD15VD3	17.6	18.0	18.4		
Reverse leakage current	I _R	V _{RWM} =3.3V			2	μA	
		V _{RWM} =5V			1	μA	
		V _{RWM} =12V			50	nA	
		V _{RWM} =15V			50	nA	
		V _{RWM} =24V			50	nA	
Diode capacitance	C _d	V _R =0V, f=1MHz				pF	
		GESD3V3D3		207	300		
		GESD5V0D3		152	200		
		GESD12VD3		38	75		
		GESD15VD3		32	70		
Clamping voltage	V _(CL)	GESD3V3D3	I _{PP} =1A			7	V
			I _{PP} =18A			20	
		GESD5V0D3	I _{PP} =1A			9	
			I _{PP} =15A			20	
		GESD12VD3	I _{PP} =1A			19	
			I _{PP} =5A			35	
		GESD15VD3	I _{PP} =1A			23	
			I _{PP} =5A			40	
		GESD24VD3	I _{PP} =1A			36	
			I _{PP} =3A			70	

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Differential resistance	R_{diff}	$I_R=1mA$	400	Ω
		$I_R=1mA$	80	
		$I_R=1mA$	200	
		$I_R=1mA$	225	
		$I_R=0.5mA$	300	

TYPICAL CHARACTERISTICS @ $T_a=25^\circ C$ unless otherwise specified

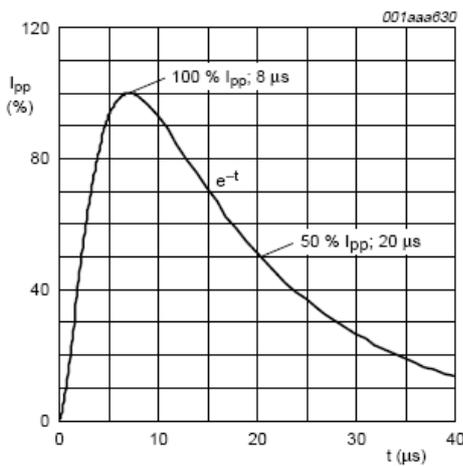


Fig 1. 8/20 us pulse waveform according to IEC 61000-4-5.

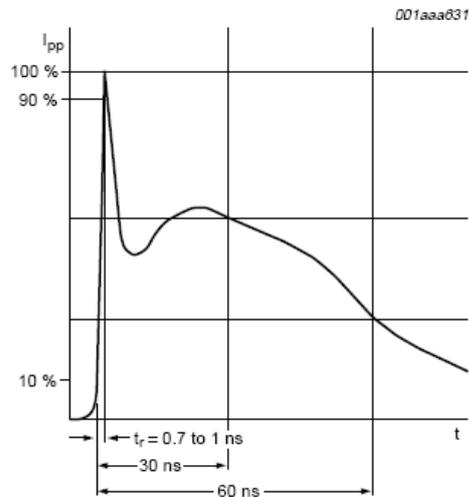
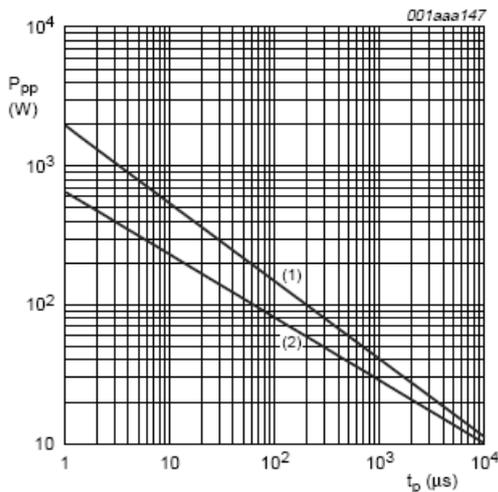


Fig 2. Electro Static Discharge(ESD) pulse waveform according to IEC 61000-4-2.



$T_{amb} = 25^\circ C$
 $t_p = 8/20 \mu s$ exponentially decay waveform,
 see **Figure 1**
 (1) GESD3V3D3 and GESD5V0D3.
 (2) GESD12VD3, GESD15VD3, GESD24VD3

Fig 3. Peak pulse power dissipation as a function of pulse time; typical values.

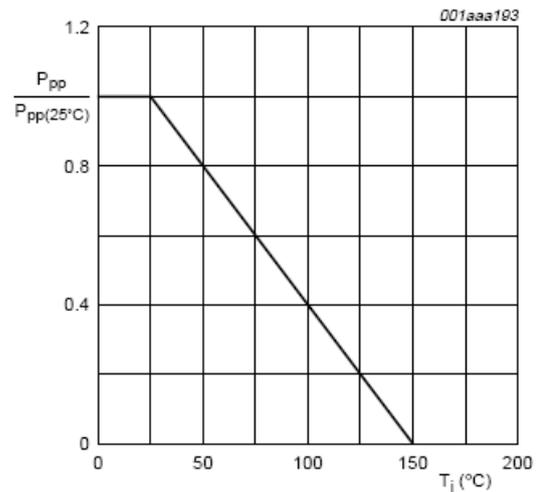
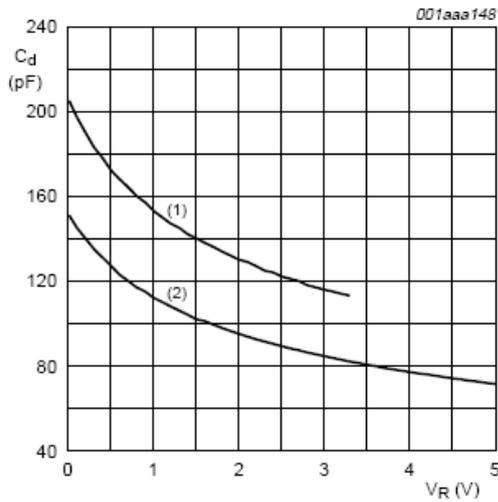


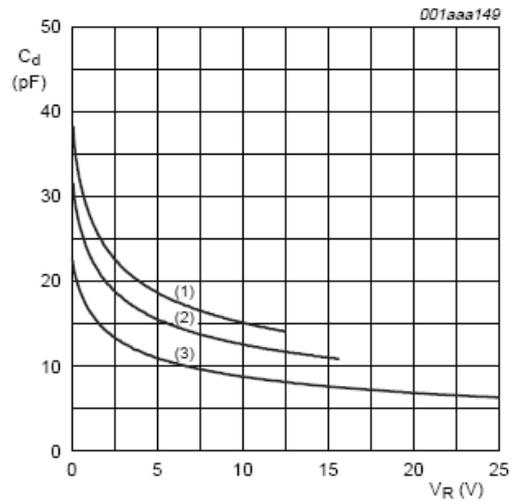
Fig 4. Relative variation of peak pulse power as a function of junction temperature; typical values.

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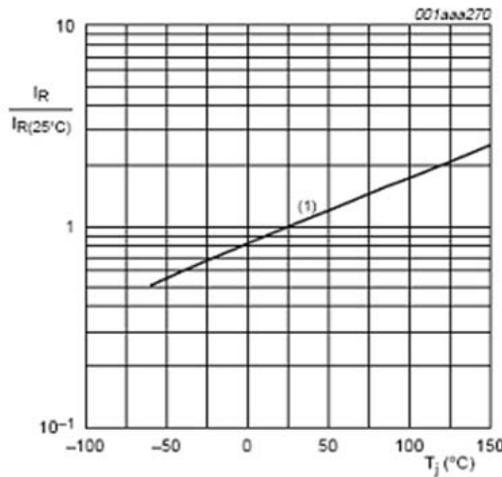
f = 1 MHz; T_{amb} = 25 °C
(1) GESD3V3D3
(2) GESD5VD3



f = 1 MHz; T_{amb} = 25 °C
(1) GESD12VD3
(2) GESD15VD3
(3) GESD24VD3

Fig 5. Diode capacitance as a function of reverse voltage;typical values.

Fig 6. Diode capacitance as a function of reverse voltage;typical values.



(1) GESD3V3D3 ; V_{RWM} = 3.3 V.
GESD5VD3 ; V_{RWM} = 5 V.
I_R is less than 10 nA at 150 °C for:
GESD12VD3 ; V_{RWM} = 12 V.
GESD15VD3 ; V_{RWM} = 15 V.
GESD24VD3 ; V_{RWM} = 24 V.

Fig 7. Relative variation of reverse leakage current as a function of junction temperature;typical values.

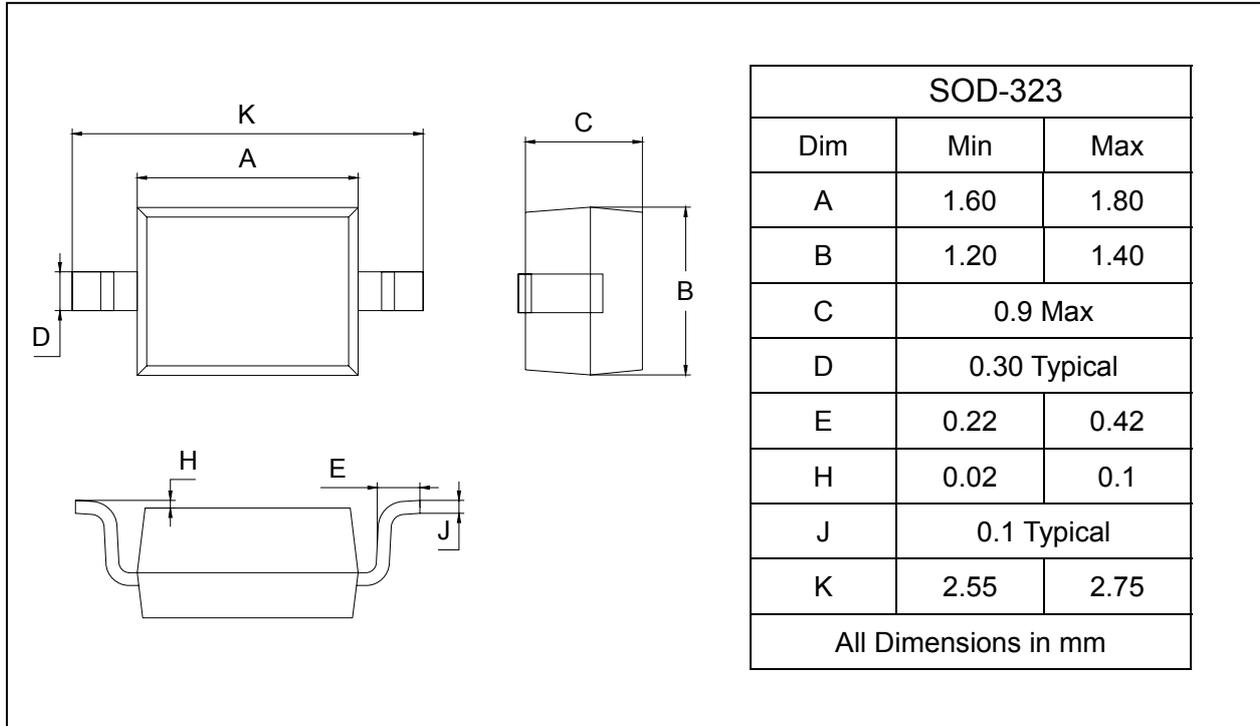
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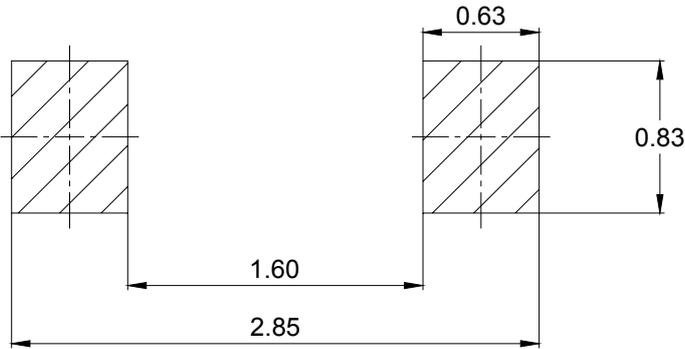
PACKAGE OUTLINE

Plastic surface mounted package

SOD-323



SOLDERING FOOTPRINT



Unit : mm

PACKAGE INFORMATION

Device	Package	Shipping
GESDXVD3	SOD-323	3000/Tape&Reel